

## UNISONIC TECHNOLOGIES CO., LTD

30NM50 Preliminary Power MOSFET

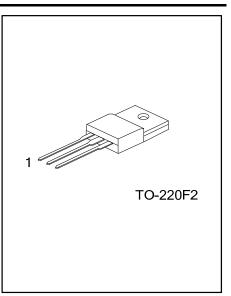
# 30A, 500V N-CHANNEL SUPER-JUNCTION MOSFET

#### **■** DESCRIPTION

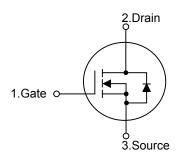
The **UTC 30NM50** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

#### **■ FEATURES**

- \*  $R_{DS(ON)}$  < 0.11 $\Omega$  @  $V_{GS}$ =10V,  $I_{D}$ =15A
- \* High Switching Speed
- \* 100% Avalanche Tested



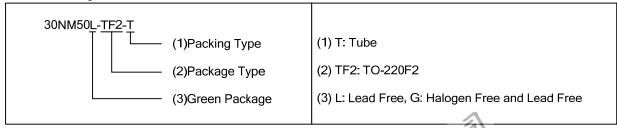
#### ■ SYMBOL



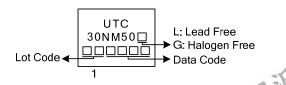
#### ORDERING INFORMATION

Ordering Number		Doolsons	Pin Assignment			Daakina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
30NM50L-TF2-T	30NM50G-TF2-T	TO-220F2	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



#### MARKING



<u>www.unisonic.com.tw</u> 1 of 5

#### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	500	<b>&gt;</b>
Gate-Source Voltage		$V_{GSS}$	±30	<b>&gt;</b>
Drain Current	Continuous	$I_{D}$	30	Α
	Pulsed (Note 2)	I <sub>DM</sub>	120	Α
Avalanche Current (Note 2)		$I_{AR}$	13.3	Α
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	1061	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	8.0	V/ns
Power Dissipation		$P_D$	130	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 12mH,  $I_{AS}$  = 13.3A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25 $^{\circ}$ C
- 4.  $I_{SD} \le 30A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

#### **■ THERMAL DATA**

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	$\theta_{JA}$	62.5	°C/W	
Junction to Case	$\theta_{ m JC}$	0.96	°C/W	

## ■ **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> =25°C, unless otherwise specified)

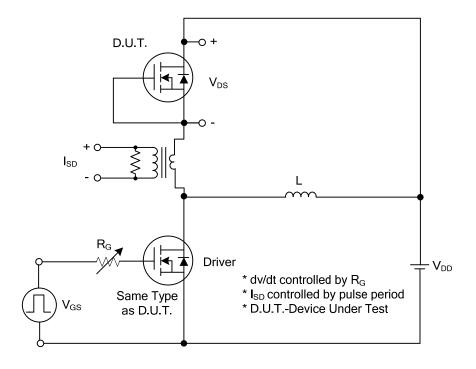
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS				I.	l			
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	500			٧	
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =500V, V <sub>GS</sub> =0V			10	μA	
Gate- Source Leakage Current	Forward	-	V <sub>GS</sub> =+30V, V <sub>DS</sub> =0V			+100	nA	
	Reverse	$I_{GSS}$	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.5		4.5	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =15A			0.11	Ω	
DYNAMIC PARAMETERS								
Input Capacitance		C <sub>ISS</sub>			2800		рF	
Output Capacitance		Coss	$V_{GS}$ =0V, $V_{DS}$ =25V, f=1.0MHz		1700		pF	
Reverse Transfer Capacitance		$C_{RSS}$			130		рF	
SWITCHING PARAMETERS								
Total Gate Charge (Note 1)		$Q_G$	V <sub>DS</sub> =50V, I <sub>D</sub> =1.3A, I <sub>G</sub> =100μA		230		nC	
Gate to Source Charge		$Q_GS$	V <sub>GS</sub> =10V (Note 1,2)		38		nC	
Gate to Drain Charge		$Q_GD$	VGS=10V (Note 1,2)		55		nC	
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$			110		ns	
Rise Time		$t_R$	$V_{DD}$ =30V, $I_{D}$ =0.5A, $R_{G}$ =25 $\Omega$ ,		345		ns	
Turn-OFF Delay Time		$t_{D(OFF)}$	V <sub>GS</sub> =10V (Note 1,2)		800		ns	
Fall-Time		$t_{F}$			530		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		$I_S$	(PL)	$U_{I,I}$		30	Α	
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>	18 18 20			120	Α	
Drain-Source Diode Forward Voltage (Note 1)		$V_{\text{SD}}$	I <sub>S</sub> =30A, V <sub>GS</sub> =0V			1.4	V	
Body Diode Reverse Recovery Time (Note 1)		t <sub>rr</sub>	I <sub>S</sub> =30A, V <sub>GS</sub> =0V,		500		ns	
Body Diode Reverse Recovery Charge		Q <sub>rr</sub>	dl <sub>F</sub> /dt=100A/µs		9.3		μC	

Notes: 1. Pulse Test : Pulse width ≤ 300µs, Duty cycle ≤ 2%.

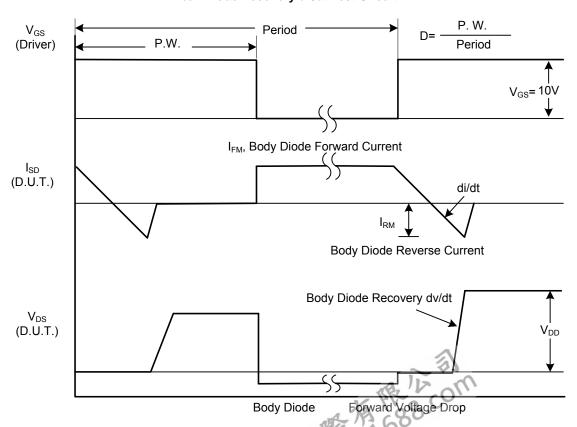
2. Essentially independent of operating ambient temperature.



#### **■ TEST CIRCUITS AND WAVEFORMS**



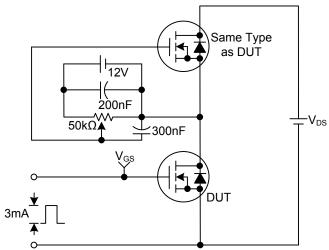
## Peak Diode Recovery dv/dt Test Circuit



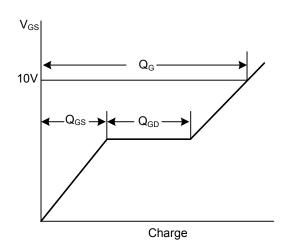
Peak Diode Recovery dv/dt Waveforms

## ■ TEST CIRCUITS AND WAVEFORMS (Cont.)

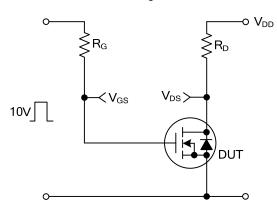
Gate Charge Test Circuit



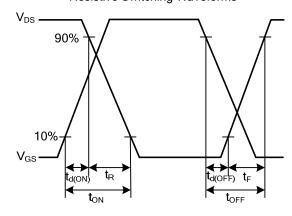
Gate Charge Waveforms



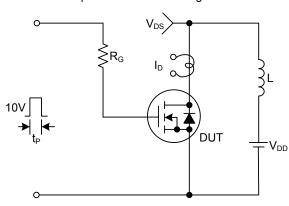
Resistive Switching Test Circuit



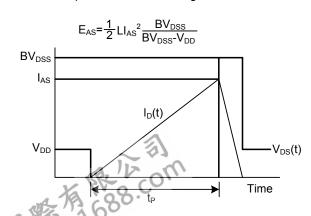
Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.

